

Chip Boxes - Assembled

Features:

- Manufactured from Corstat conductive corrugated fibre-board, our chip boxes provide an ESD safe and cost effective method of shipping chips and small electronic devices.
- Assembled with high density pin stick grade conductive foam.



Product Code:	Description:	Size (mm):	Additional Notes:
1687873	Chip Box with conductive foam	120 x 100 x 15	Assembled (Ref: 026-0466)

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